# 1-1939761-0 ACTIVE

#### Dynamic Series | Dynamic 1000 Series

TE Internal #: 1-1939761-0

PCB Mount Header, Horizontal, Wire-to-Board, 10 Position, 2 mm [. 079 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder,

Dynamic 1000 Series

View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles > Header Assembly: Wire-to-Board, 3A, Gold or Tin Plated



PCB Connector Assembly Type: PCB Mount Header

Connector System: Wire-to-Board

Number of Positions: 10

Number of Rows: 1

Centerline (Pitch): 2 mm [.079 in]

All Header Assembly: Wire-to-Board, 3A, Gold or Tin Plated (53)

#### **Features**

#### **Product Type Features**

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PCB Connector Assembly Type	PCB Mount Header
Connector System	Wire-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Positions	10
Number of Rows	1
PCB Mount Orientation	Horizontal
Body Features	
Primary Product Color	Black

### **Contact Features**



Contact Mating Area Plating Material Thickness	2 μm[80 μin]
Contact Mating Area Plating Material Finish	Matte
Contact Mating Area Plating Material	Tin
Contact Type	Pin
Contact Current Rating (Max)	3 A
Termination Features	
Termination Method to PCB	Through Hole - Solder
Mechanical Attachment	
Mating Alignment Type	Keyed
Mating Retention	With
PCB Mount Retention Type	Retention Leg
Connector Mounting Type	Board Mount
Mating Alignment	With
PCB Mount Alignment	Without
PCB Mount Retention	With

## **Housing Features**

Housing Material	Polyester GF
Centerline (Pitch)	2 mm[.079 in]

## **Usage Conditions**

Operating Temperature Range	-55 - 105 °C[-67 - 221 °F]
operating remperature runge	

## **Industry Standards**

UL Flammability Rating	UL 94V-0
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## Packaging Features

## **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241)



Candidate List Declared Against: JUNE 2024 (241)

Does not contain REACH SVHC

Halogen Content

Not Low Halogen - contains Br or Cl > 900 ppm.

Solder Process Capability Wave solder capable to 265°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

## Compatible Parts



# Also in the Series | Dynamic 1000 Series



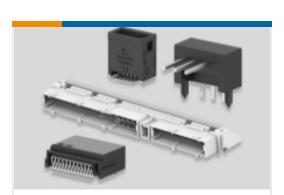
Connector Contacts(40)



Connector Hardware(3)

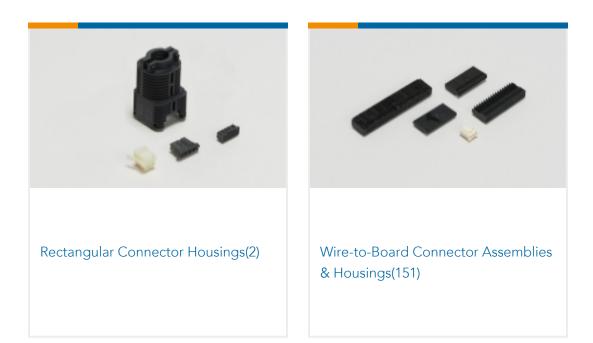


Insertion & Extraction Tools(2)



PCB Headers & Receptacles(169)





# Customers Also Bought











#### **Documents**

**CAD Files** 

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_1-1939761-0\_B.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_1-1939761-0\_B.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_1-1939761-0\_B.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use

**Product Specifications** 

**Application Specification** 

English

PCB Mount Header, Horizontal, Wire-to-Board, 10 Position, 2 mm [.079 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Dynamic 1000 Series



Agency Approvals
TUV Certificate

English